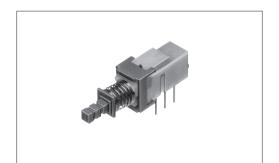
2.5mm-travel Large-sized Horizontal Type

Large horizontal type suitable for multiple circuits





■ Typical Specifications

l+o	ma	Specifications			
ite	ms	Standard	Medium-current		
Rating (max.)/(m (Resistive load)	in.)	0.1A 30V DC 50 μA 3V DC 1A 25V DC			
Contact resistance (Initial /After operation	-	20mΩ max. / 40mΩ max.			
Operating forces	2-pole	2±1N	3±1.5N		
	4-pole	2.5±1N	4±2N		
Operating life	Without load Operating life With load		10,000 cycles		
Operating life			5,000 cycles (1A 25V DC)		

Product Line

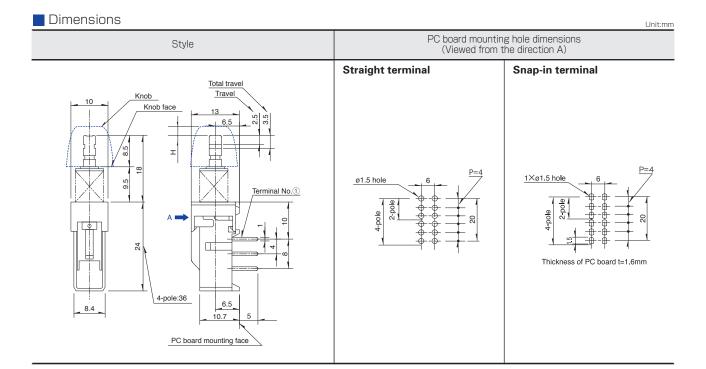
Changeover timing	Travel (mm)	Total travel (mm)	Rating	Mounting method	Poles	Operation	Terminal type	Minimum ord Japan	er unit (pcs.) Export	Product No.
Non shorting		2.5 3.5 Medium	Standard			Latching -	Straight		1,250	SPUN191400
							Snap-in	250		SPUN191600
							Straight			SPUN190900
	2.5				Momentary	Snap-in			SPUN191000	
				4 Sna Latching Stra	1	Straight	140	700	SPUN194700	
					4		Snap-in	140	, 00	SPUN194900
					2	Latching	Straight	250	1,250	SPUN192600
			Medium- current				Snap-in	250	1,230	SPUN192800
					Jildp-III	140	700	SPUN19C400		

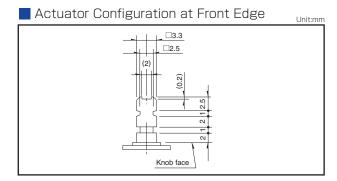
Packing Specifications

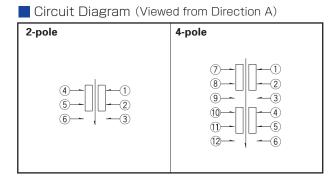
Bulk

Product No.	Number of pa	Export package		
Floddet No.	1 case / Japan	1 case / export packing	measurements (mm)	
SPUN190900, SPUN191000 SPUN191400, SPUN191600 SPUN192600, SPUN192800	250	1,250	400×270×290	
SPUN194700, SPUN194900 SPUN19C400	140	700		





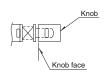




Attached Parts Please specify required knob. Knob outline drawing Model Knob attachment height (H) Square knob UE201011 Process Color:Black UE200011 General Specific Required knob. Unitume Model Knob attachment height (H) VECOIO:Black UE201011 Process UE200011 General Specific Required knob. Unitume Model Knob attachment height (H) UE201011 Process UE201011 Attached Parts Please specify required knob. Unitume Model Knob attachment height (H) UE201011 Attached Parts Please specify required knob. Unitume Model Knob attachment height (H) Brown Attachment height (H) Attached Parts Please specify required knob. UE201011 Attached Parts Please specify required knob. Attac

Notes

- 1. Other knob varieties are also available. Please inquire.
- 2. We recommend the use of adhesive to secure the knob when mounting onto switches.





	Series				Horizontal				
	561162		SPPJ3	SPPJ2	SPUJ*	SPUN	SPUN medium current*		
ı	Photo								
Dimensions (mm) D		5 or 6.6	3 7.2 7.5		10				
		D	1	2	15.2 22.7	24 36			
		Н	8.3	9.6	8.8		13		
Tra	vel (mm)	2	5	2		2.5		
Total ⁻	travel (n	nm)	3	.5	3		3.5		
Numb	er of po	les	1 2	2		2 4			
	perating rature ra		-40℃ to +85℃		-10°C to	o +60℃			
Autor	motive u	ise	•	•	_	_	_		
Life cycle		*3	*3	*3		★3			
Rating (max.) (Resistive load)			0.2A 3	0.2A 30V DC 0.1A 30V DC					
	ating (min.) sistive load) 50 μ A 3V DC					1A 25V DC			
Durability	Opera witho	nting life out load	10	10,000 cycles $40mΩ$ max. 30,000 cycles $40mΩ$ max.			10,000 cycles 40mΩ max.		
Durability		life with load rated load)		10,000 cycles 40mΩ max.					
		contact stance			20mΩ max.				
Electrical performance		llation stance		100MΩ min. 500V DC					
	Voltag	ge proof			500V AC for 1minute				
		minal ength	5N for 1minute						
Mechanical performance	Actuato	Operating direction	50N	30N		50N			
	strength	strength Pulling direction	_						
Cold			-40°C 96h -20°C 96h						
Environmental performance	Dry	heat	85°C 961			96h			
	Dam	p heat		4	40°C, 90 to 95%RH 96l	h			
	Page		118	120	122		124		

Notes

- 1. * The operating temperature range for automotive applications can be raised upon request. Please contact us for details.
- 2. Indicates applicability to all products in the series.

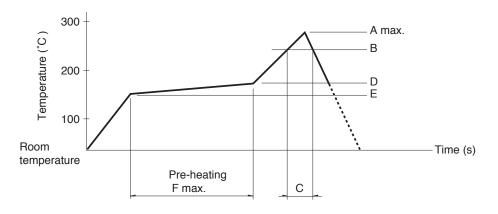
Vertica

■ Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.

Push Switches Soldering Conditions

3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (°C)	E (℃)	F(s)
SPEG						
SPEJ	260	230	40	180	150	120
SPEF	200					
SPEH						

Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc.

 The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPPJ3, SPPJ2, SPUN, SPPH4, SPPH1	350±10℃	3+1/0s	
SPED2, SPED4	350±10℃	3±0.5s	
SPEJ	350±10℃	4s max.	
SPEG, SPEF	350±5℃	3s max.	
SPEH, SPPH2	350°C max.	3s max.	
SPUJ	300±10°C	3+1/0s	

Reference for Dip Soldering (For PC board terminal types)

Series	Ite	ms	Dip soldering		
Jenes	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SPPJ3	100℃ max.	60s max.	260±5℃	5±1s	
SPUN	100℃ max. 60s max.		260±5℃	10±1s	
SPUJ, SPPH2, SPPH4	_		260±5℃	5±1s	
SPPJ2, SPPH1, SPED2, SPED4, SPEF	_		260±5℃	10±1s	



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ALPS:

<u>SPUN190900</u> <u>SPUN191000</u> <u>SPUN191400</u> <u>SPUN191600</u> <u>SPUN192600</u> <u>SPUN192800</u> <u>SPUN192800</u> <u>SPUN194700</u> SPUN194900 SPUN19C400